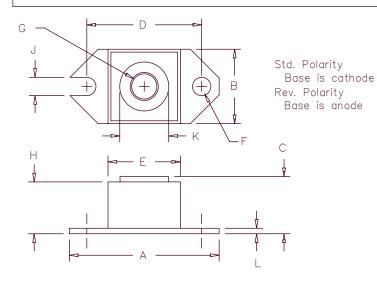
240 Amp Schottky Rectifier HS24380 — HS243100



Dim. Inches Mi			Millimete	Millimeter		
	Minimum	Maximum	Minimum	Maximum	Notes	
А	1.52	1.56	38.61	39.62		
В	.725	.775	18.42	19.69		
С	.605	.625	15.37	15.88		
D	1.182	1.192	30.02	30.28		
Ε	.745	.755	18.92	19.18	Sq.	
F	.152	.160	3.86	4.06	Sq. Dia.	
G	1/4-20 UNC-2B					
Н	.525	.580	13.34	14.73		
J	.156	.160	3.96	4.06		
K	.495	.505	12.57	12.83	Dia.	
L	.120	.130	3.05	3.30		

Microsemi Catalog Number	Industry Part Number	Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
HS24380*	243NQ080	80V	80V
HS24390*	MBR24080	90V	90V
HS243100*	243NQ100 MBR240100	100V	100V
	*Add Suffix R	for Reverse Polarit	tv

- Schottky Barrier Rectifier
- Guard Ring Protection
- 240 Amperes/80 to 100 Volts
- 175°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

 $^{T}C = 122^{\circ}C$, Square wave, $^{R}\Theta JC = .24^{\circ}C/W$ F(AV) 240 Amps Average forward current 8.3ms, half sine, $^{\mathsf{T}}\mathsf{J} = 175^{\circ}\mathsf{C}$ f = 1 KHZ, 25 $^{\circ}\mathsf{C}$ Maximum surge current FSM 3300 Amps Maximum repetitive reverse current R(OV) 2 Amps $^{1}FM = 240A: TJ = 175^{\circ}C^{*}$ Max peak forward voltage VFM 0.72 Volts TFM = 240A: TJ = 25°C* VRRM, TJ = 125°C* V_{FM} Max peak forward voltage 0.86 Volts Max peak reverse current ^IRM 200mA VRRM, TJ = 25°C Max peak reverse current ^IRM 8.0mA Typical junction capacitance C_{J} $VR = 5.0V, TC = 25^{\circ}C$ 6400pF

Thermal and Mechanical Characteristics

*Pulse test: Pulse width 300 µsec, Duty cycle 2%

-55°C to 175°C -55°C to 175°C Storage temp range ΤĴ Operating junction temp range 0.24°C/W Junction to case R OJC Max thermal resistance Recs 0.12°C/W Case to sink Typical thermal resistance (greased) 35-40 inch pounds Terminal Torque Mounting Base Torque 20-25 inch pounds Weight 1.1 ounces (32 grams) typical



HS24380 HS243100

Figure 1 Typical Forward Characteristics

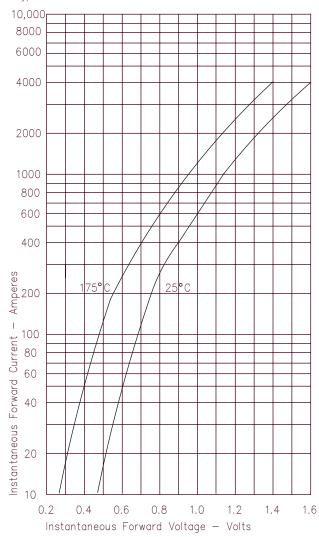


Figure 3 Typical Junction Capacitance

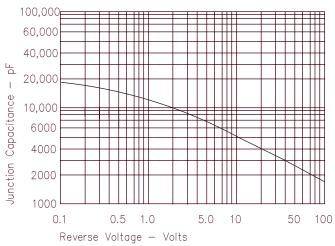


Figure 4

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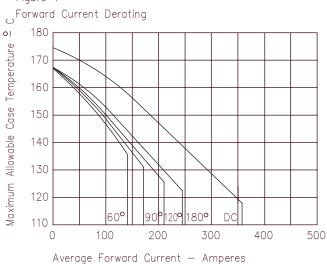


Figure 2 Typical Reverse Characteristics

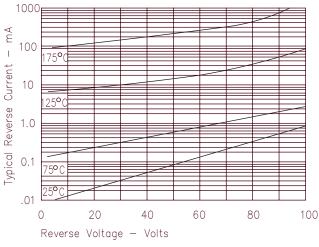
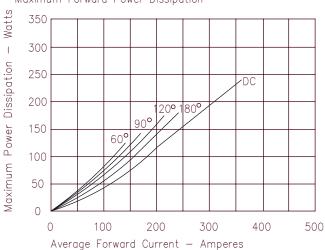


Figure 5 Maximum Forward Power Dissipation





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